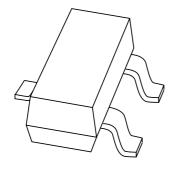
DISCRETE SEMICONDUCTORS

DATA SHEET



PMBT4403 PNP switching transistor

Product data sheet Supersedes data of 1999 Apr 15 2004 Jan 21



PNP switching transistor

PMBT4403

FEATURES

• High current (max. 600 mA)

• Low voltage (max. 40 V).

APPLICATIONS

• Industrial and consumer switching applications.

DESCRIPTION

PNP switching transistor in a SOT23 plastic package. NPN complement: PMBT4401.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾	
PMBT4403	*2T	

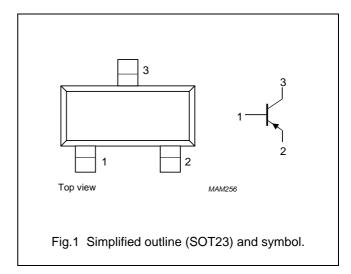
Note

1. * = p : Made in Hong Kong.* = t : Made in Malaysia.

* = W : Made in China.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

ТҮРЕ		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
PMBT4403	_	plastic surface mounted package; 3 leads	SOT23

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	_	-40	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-600	mA
I _{CM}	peak collector current		_	-800	mA
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

PNP switching transistor

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

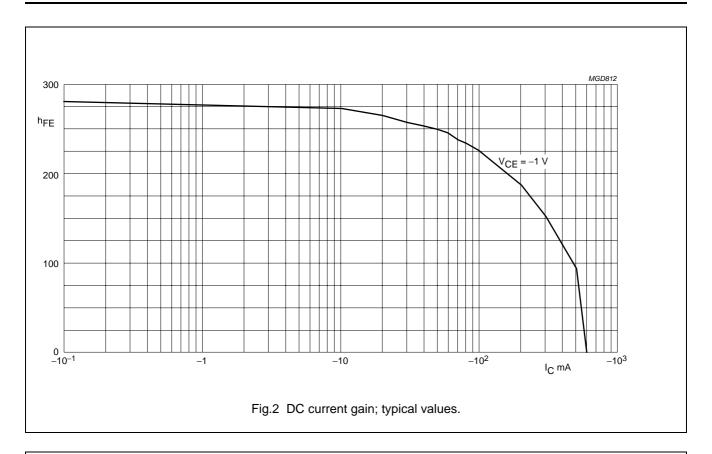
CHARACTERISTICS

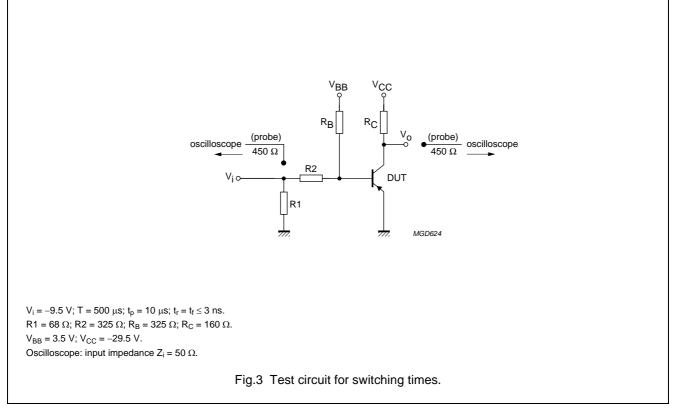
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = -40 V	_	-50	nA	
I _{EBO}	emitter-base cut-off current	$I_C = 0; V_{EB} = -5 \text{ V}$	_	-50	nA	
h _{FE}	DC current gain	V _{CE} = −1 V; (see Fig.2)				
		$I_{\rm C} = -0.1 \text{mA}$	30	_		
		$I_C = -1 \text{ mA}$	60	_		
		$I_{C} = -10 \text{ mA}$	100	_		
		V _{CE} = −2 V				
		$I_{\rm C} = -150 \rm mA$	100	300		
		$I_C = -500 \text{ mA}$	20	_		
V _{CEsat}	collector-emitter saturation	$I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$	_	-400	mV	
	voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	-750	mV	
V _{BEsat}	base-emitter saturation voltage	$I_C = -150 \text{ mA}; I_B = -15 \text{ mA}$	_	-950	mV	
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	-1.3	V	
C _c	collector capacitance	$I_E = I_e = 0$; $V_{CB} = -10 \text{ V}$; $f = 1 \text{ MHz}$	_	8.5	pF	
Ce	emitter capacitance	$I_C = I_c = 0$; $V_{EB} = -500 \text{ mV}$; $f = 1 \text{ MHz}$	_	35	pF	
f _T	transition frequency	$I_C = -20 \text{ mA}; V_{CE} = -10 \text{ V}; f = 100 \text{ MHz}$	200	_	MHz	
Switching times (between 10% and 90% levels); (see Fig.3)						
t _{on}	turn-on time	$I_{Con} = -150 \text{ mA}; I_{Bon} = -15 \text{ mA};$	_	40	ns	
t _d	delay time	I _{Boff} = 15 mA	_	15	ns	
t _r	rise time		_	30	ns	
t _{off}	turn-off time]	_	350	ns	
t _s	storage time]	_	300	ns	
t _f	fall time		_	50	ns	

PNP switching transistor

PMBT4403

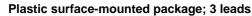




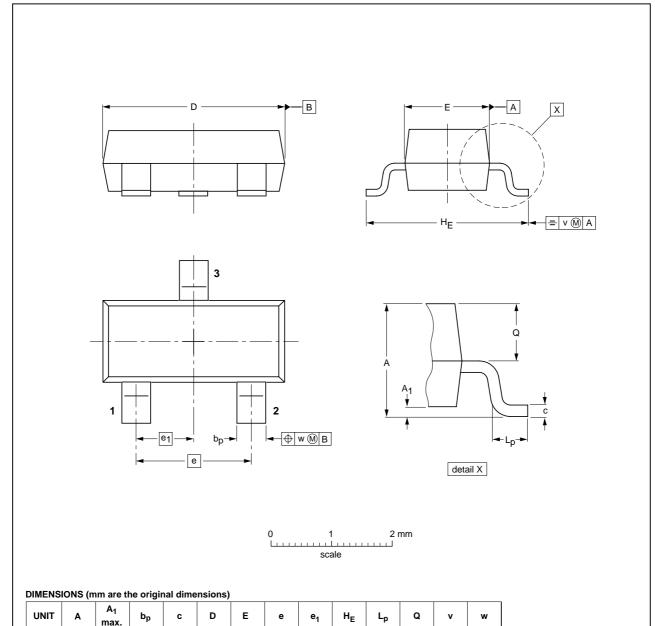
PNP switching transistor

PMBT4403

PACKAGE OUTLINE



SOT23



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				04-11-04 06-03-16

1.9

0.45

0.55

0.1

2004 Jan 21 5

max

0.9

0.48

0.38

PNP switching transistor

PMBT4403

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com
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